

1011LD300

300 Watts, 32 Volts Pulsed Avionics 1030 to 1090 MHz LDMOS FET

GENERAL DESCRIPTIO The 1011LD300 is a COMMOU lateral MOSFET capable of provid MHz. The device is nitride passiv highest MTTF. The transistor incl Low thermal resistance package re	CASE OUTLINE 55QM (Common Source)	
ABSOLUTE MAXIMUM Power Dissipation Device Dissipation @25°C (P _d) Voltage and Current Drain-Source (V _{DSS})	RATINGS 1590 W 75V	
Gate-Source (V _{GS})	$\pm 20 \mathrm{V}$	
Temperatures Storage Temperature Operating Junction Temperature	-65 to +150°C +200°C	

ELECTRICAL CHARACTERISTICS @ 25°C

SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS
BV _{dss}	Drain-Source Breakdown	$V_{gs} = 0V, I_d = 30mA$	75			V
I _{dss}	Drain-Source Leakage Current	$V_{ds} = 38V, V_{gs} = 0V$			10	μΑ
I _{gss}	Gate-Source Leakage Current	$V_{gs} = 10V, V_{ds} = 0V$			2	μΑ
V _{gs(th)}	Gate Threshold Voltage	$V_{ds} = 10V, I_d = 60 \text{ mA}$	3		6	V
V _{ds(on)}	Drain-Source On Voltage	$V_{gs} = 10V, I_d = 3A$			0.3	V
g _{FS}	Forward Transconductance	$V_{ds} = 10V, I_d = 3A$		3		S
θ_{JC}^{1}	Thermal Resistance				.11	°C/W

FUNCTIONAL CHARACTERISTICS (a) 25°C, Vds = 32V, I_{dq} = 750mA

G _{PS}	Common Source Power Gain	Pulse width = 32 μ s, LTDC=2%	13	14		dB
Pd	Pulse Droop	F=1030/1090 MHz, P _{out} = 300W			0.5	dB
η_d	Drain Efficiency	$F = 1030 \text{ MHz}, P_{out} = 300 \text{ W}$	43			%
ψ	Load Mismatch	$F = 1090 \text{ MHz}, P_{out} = 300 \text{ W}$			3:1	

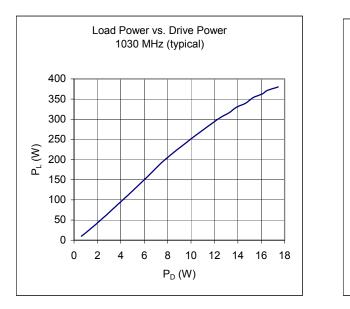
NOTES: 1. At rated output power and pulse conditions

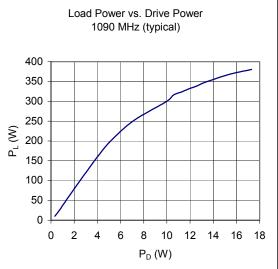
2. Pulse Format 1: 32µs, 2% Long Term Duty Factor

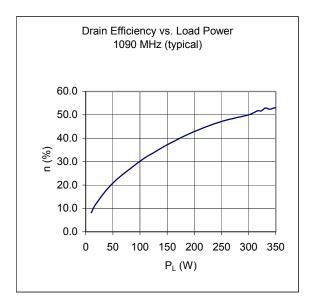
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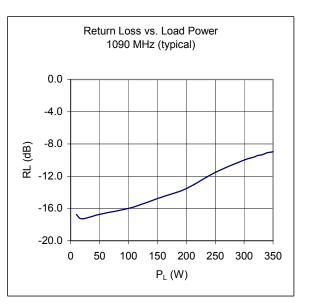




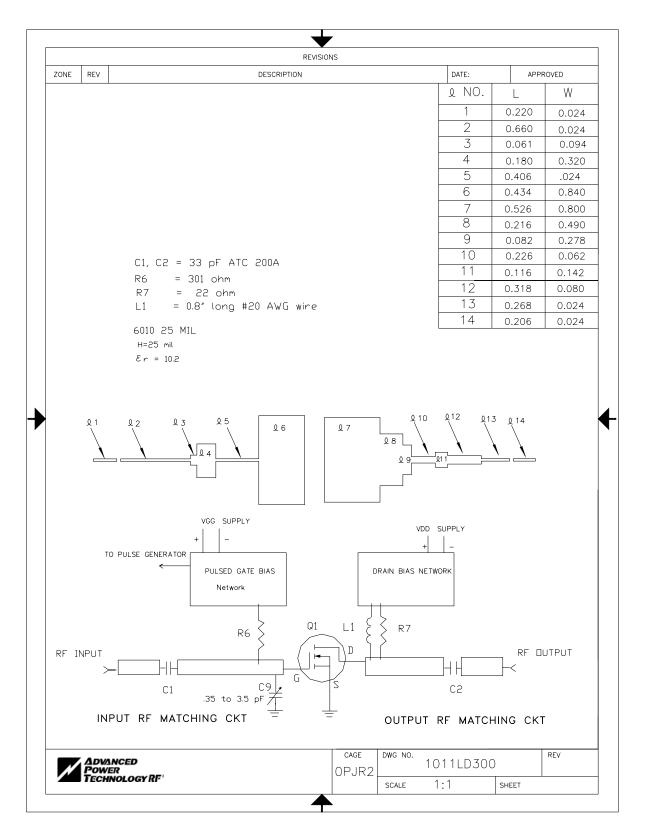








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